

Part Number:

2.0x1.25mm SMD CHIP LED LAMP

# XZUY54W

## **Features**

- 2.0mmx1.25mm SMT LED,1.1mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.

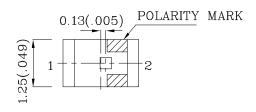


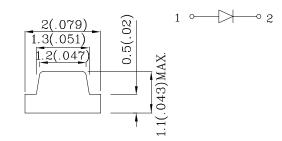


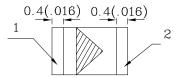
#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Rating (TA=25°C)	UY (GaAsP/GaP)	Unit		
Reverse Voltage	VR	5	V	
Forward Current	IF	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA	
Power Dissipation	Рт	75	mW	
Operating Temperature	TA	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		







Operating Characteristi (TA=25°C)	UY (GaAsP/GaP)	Unit	
Forward Voltage (Typ.) (IF=20mA)	VF	2.1	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength Of Peak Emission (Typ.) (IF=20mA)	λΡ	590	nm
Wavelength Of Dominant Emission (Typ.) (IF=20mA)	λ D	588	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	35	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	20	pF

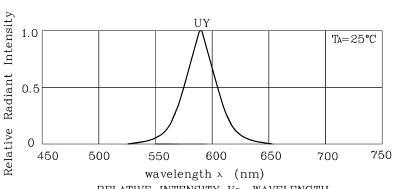
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
XZUY54W	Yellow	GaAsP/GaP	Water Clear	2.6	7	590	120°
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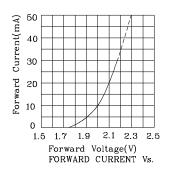
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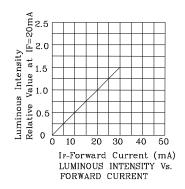


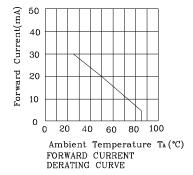


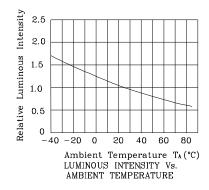
RELATIVE INTENSITY Vs. WAVELENGTH

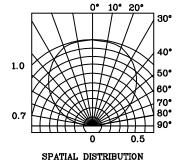
**♦** UY











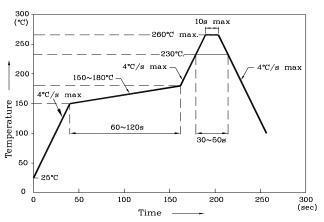
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Reflow Soldering Profile For Lead-free SMT Process.

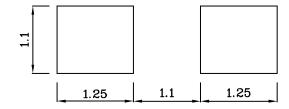


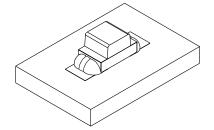
#### Notes:

- 1. Maximum soldering temperature should not exceed  $260 \, ^{\circ} \text{C}$ .
- 2. Recommended reflow temperature:  $145^{\circ}c-260^{\circ}C$ .
- 3.Do not put stress to the epoxy resin during high temperatures conditions.

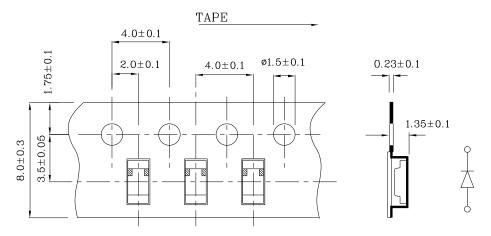
# ❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

♦ The device has a single mounting surface. The device must be mounted according to the specifications.





\* Tape Specification (Units:mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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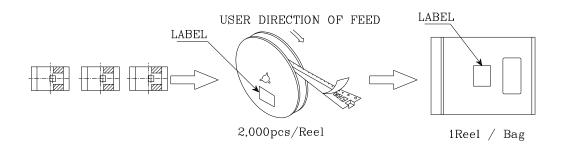


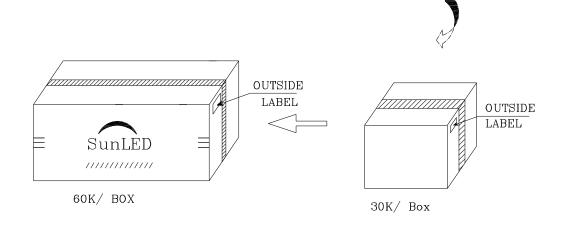
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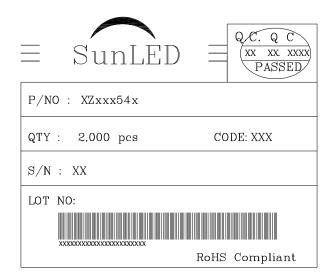
 $2.0\mathrm{x}1.25\mathrm{mm}$  SMD CHIP LED LAMP

## PACKING & LABEL SPECIFICATIONS

## XZUY54W







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